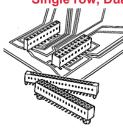
91601-314LF - DUBOX™ : 14 **Position Vertical Card Connector, Surface Mount,** Single row, Dual entry









▶77311-401-14LF №95293-101-14LF

Specifications

Thickness (Board) 1.6 mm (0.062 in.) or 2.36 mm (0.093 in.) Footprint (Board) 2.54 mm x 4.2 mm (0.1 in. x 0.165 in.) Electrical Current rating 3A max. per Contact/2A max. per Contact for Full Load Resistance (Contact) 15 milli ohms Initial, 20 milli ohms After test Resistance (Insulation) 100000 M-ohms Voltage rating 10000V rms Mechanical Insertion force 1.50N (150 gf) per Contact Withdrawal Force 0.3N (30 gf) min. per Contact	General	
Number of contacts (Total) 14 Number of rows 1 Orientation Vertical Packaging Tube Mating half Mates with 0.64 mm (0.025 in.) Square pins. Series Number 91601 Dimensional Thickness (Board) 1.6 mm (0.062 in.) or 2.36 mm (0.093 in.) Footprint (Board) 2.54 mm x 4.2 mm (0.1 in. x 0.165 in.) Electrical Current rating 3A max. per Contact/2A max. per Contact for Full Load Resistance (Contact) 15 milli ohms Initial, 20 milli ohms After test Resistance (Insulation) 100000 M-ohms Voltage rating 10000 M-ohms Voltage rating 10000 V rms Mechanical Insertion force 1.50N (150 gf) per Contact Withdrawal Force 0.3N (30 gf) min. per Contact Mounting Compatible with Wave, Vapor - Phase Physical Color (Housing) Grey Material (Contact) Phosphor Bronze Material (Housing) High Temperature Thermoplastic Plating (Contact area) 0.76 μm (30 μin.) Gold Plating (Ta	Hold Down Style	No Locating Pegs
Number of rows 1 Orientation Vertical Packaging Tube Mating half Mates with 0.64 mm (0.025 in.) Square pins. Series Number 91601 Dimensional	Number of contacts (per row)	14
Orientation Vertical Packaging Tube Mating half Mates with 0.64 mm (0.025 in.) Square pins. Series Number 91601 Dimensional Thickness (Board) Thickness (Board) 1.6 mm (0.062 in.) or 2.36 mm (0.093 in.) Footprint (Board) 2.54 mm x 4.2 mm (0.1 in. x 0.165 in.) Electrical Current rating 3A max. per Contact/2A max. per Contact for Full Load Resistance (Contact) 15 milli ohms Initial, 20 milli ohms After test Resistance (Insulation) 100000 m-ohms Voltage rating 100000 m-ohms Mechanical Insertion force 1.50N (150 gf) per Contact Withdrawal Force 0.3N (30 gf) min. per Contact Mounting Solder process Compatible with Wave, Vapor - Phase Physical Grey Material (Contact) Phosphor Bronze Material (Housing) High Temperature Thermoplastic Plating (Contact area) 0.76 μm (30 μin.) Gold Plating (Tail) 2.54 μm (100 μin.) Tin Underplating (Contact) 1.27 μm (50 μin.) Nickel	Number of contacts (Total)	14
Packaging Mating half Mates with 0.64 mm (0.025 in.) Square pins. Series Number Dimensional Thickness (Board) 1.6 mm (0.062 in.) or 2.36 mm (0.093 in.) Footprint (Board) 2.54 mm x 4.2 mm (0.1 in. x 0.165 in.) Electrical Current rating 3A max. per Contact/2A max. per Contact for Full Load Resistance (Contact) 15 milli ohms Initial, 20 milli ohms After test Resistance (Insulation) 10000 M-ohms Voltage rating 1000V rms Mechanical Insertion force 1.50N (150 gf) per Contact Withdrawal Force 3.3N (30 gf) min. per Contact Mounting Solder process Compatible with Wave, Vapor - Phase Physical Color (Housing) Grey Material (Contact) Phosphor Bronze Material (Contact) High Temperature Thermoplastic Plating (Contact area) Plating (Tail) 2.54 µm (100 µin.) Tin Underplating (Contact) 1.27 µm (50 µin.) Nickel	Number of rows	1
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Series Number 91601 Dimensional Thickness (Board) 1.6 mm (0.062 in.) or 2.36 mm (0.093 in.) Footprint (Board) 2.54 mm x 4.2 mm (0.1 in. x 0.165 in.) Electrical Current rating 3A max. per Contact/2A max. per Contact for Full Load Resistance (Contact) 15 milli ohms Initial, 20 milli ohms After test Resistance (Insulation) 100000 M-ohms Voltage rating 10000 m-ohms Withdrawal Force 1.50N (150 gf) per Contact Withdrawal Force 0.3N (30 gf) min. per Contact Mounting Solder process Compatible with Wave, Vapor - Phase Physical Color (Housing) Grey Material (Contact) Phosphor Bronze Material (Housing) High Temperature Thermoplastic Plating (Contact area) 0.76 μm (30 μin.) Gold Plating (Tail) 2.54 μm (100 μin.) Tin Underplating (Contact) 1.27 μm (50 μin.) Nickel	Packaging	Tube
Dimensional Thickness (Board) 1.6 mm (0.062 in.) or 2.36 mm (0.093 in.)	Mating half	Mates with 0.64 mm (0.025 in.) Square pins.
Thickness (Board)		91601
Pootprint (Board) 2.54 mm x 4.2 mm (0.1 in. x 0.165 in.)	Dimensional	
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Resistance (Insulation) Voltage rating 10000 M-ohms 1000V rms Mechanical Insertion force 1.50N (150 gf) per Contact Withdrawal Force 0.3N (30 gf) min. per Contact Mounting Solder process Compatible with Wave, Vapor - Phase Physical Color (Housing) Grey Material (Contact) Phosphor Bronze Material (Housing) High Temperature Thermoplastic Plating (Contact area) Plating (Contact) 2.54 µm (100 µin.) Tin Underplating (Contact) Voltage rating 10000 M-ohms 1.50N (150 gf) per Contact 0.3N (30 gf) min. per Contact Phosphor Bronze Phosphor Bronze 1.27 µm (50 µin.) Nickel	Current rating	3A max. per Contact/2A max. per Contact for Full Load
Voltage rating Mechanical Insertion force 1.50N (150 gf) per Contact Withdrawal Force 0.3N (30 gf) min. per Contact Mounting Solder process Compatible with Wave, Vapor - Phase Physical Color (Housing) Grey Material (Contact) Material (Housing) High Temperature Thermoplastic Plating (Contact area) Plating (Tail) Underplating (Contact) 1.27 μm (50 μin.) Nickel	Resistance (Contact)	15 milli ohms Initial, 20 milli ohms After test
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Withdrawal Force0.3N (30 gf) min. per ContactMounting Solder processCompatible with Wave, Vapor - PhasePhysical Color (Housing)GreyMaterial (Contact)Phosphor BronzeMaterial (Housing)High Temperature ThermoplasticPlating (Contact area)0.76 μm (30 μin.) GoldPlating (Tail)2.54 μm (100 μin.) TinUnderplating (Contact)1.27 μm (50 μin.) Nickel	Mechanical	
Mounting Solder processCompatible with Wave, Vapor - PhasePhysical Color (Housing)GreyMaterial (Contact)Phosphor BronzeMaterial (Housing)High Temperature ThermoplasticPlating (Contact area)0.76 μm (30 μin.) GoldPlating (Tail)2.54 μm (100 μin.) TinUnderplating (Contact)1.27 μm (50 μin.) Nickel	Insertion force	1.50N (150 gf) per Contact
Solder processCompatible with Wave, Vapor - PhasePhysical Color (Housing)GreyMaterial (Contact)Phosphor BronzeMaterial (Housing)High Temperature ThermoplasticPlating (Contact area)0.76 μm (30 μin.) GoldPlating (Tail)2.54 μm (100 μin.) TinUnderplating (Contact)1.27 μm (50 μin.) Nickel	Withdrawal Force	0.3N (30 gf) min. per Contact
Physical Color (Housing)Material (Contact)Phosphor BronzeMaterial (Housing)High Temperature ThermoplasticPlating (Contact area)0.76 μm (30 μin.) GoldPlating (Tail)2.54 μm (100 μin.) TinUnderplating (Contact)1.27 μm (50 μin.) Nickel	Mounting	
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Material (Contact)Phosphor BronzeMaterial (Housing)High Temperature ThermoplasticPlating (Contact area)0.76 μm (30 μin.) GoldPlating (Tail)2.54 μm (100 μin.) TinUnderplating (Contact)1.27 μm (50 μin.) Nickel	-	Crov
Material (Housing)High Temperature ThermoplasticPlating (Contact area)0.76 μm (30 μin.) GoldPlating (Tail)2.54 μm (100 μin.) TinUnderplating (Contact)1.27 μm (50 μin.) Nickel	ν, σ,	•
Plating (Contact area)0.76 μm (30 μin.) GoldPlating (Tail)2.54 μm (100 μin.) TinUnderplating (Contact)1.27 μm (50 μin.) Nickel		·
Plating (Tail)2.54 μm (100 μin.) TinUnderplating (Contact)1.27 μm (50 μin.) Nickel		
Underplating (Contact) 1.27 μm (50 μin.) Nickel	Plating (Contact area)	0.76 μm (30 μin.) Gold
	Plating (Tail)	2.54 μm (100 μin.) Tin
Flammability rating UL 94 V-0	Underplating (Contact)	1.27 μm (50 μin.) Nickel
	Flammability rating	UL 94 V-0

Temperature (Range)	-65 °C to +125 °C
Approvals / Certifications UL File Number	E66906
Approvals / Certifications	UL and CSA Approved

